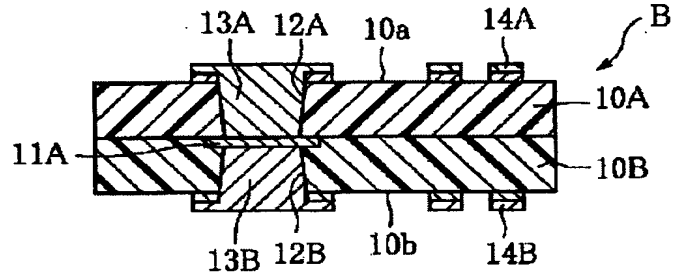


# Patent Abstracts of Japan

TITLE : CORE SUBSTRATE AND MULTILAYER  
CIRCUIT BOARD USING THE SAME



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